74F646 Octal Transceiver/Register with 3-STATE Outputs

74F646 Octal Transceiver/Register with 3-STATE Outputs

General Description

FAIRCHILD

SEMICONDUCTOR

These devices consist of bus transceiver circuits with 3-STATE, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes to a high logic level. Control \overline{G} and direction pins are provided to control the transceiver function. In the transceiver mode, data present at the high impedance port may be stored in either the A or the B register or in both. The select controls can multiplex stored and real-time (transparent mode) data. The direction control determines which bus will receive data when the enable control \overline{G} is Active LOW. In the isolation mode (control \overline{G} HIGH), A data may be stored in the B register and/or B data may be stored in the A register.

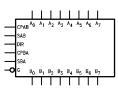
Features

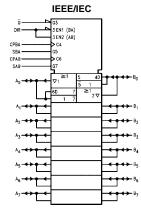
- Independent registers for A and B buses
- Multiplexed real-time and stored data
- 74F646 has non-inverting data paths
- 3-STATE outputs
- 300 mil slim DIP

Ordering Code:

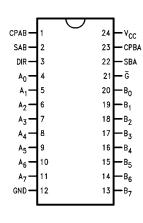
Order Number	Package Number	Package Description						
74F646SC	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide						
74F646MSA	MSA24	24-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide						
74F646SPC N24C 24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide								
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.								

Logic Symbols





Connection Diagram



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74F646

Unit Loading/Fan Out

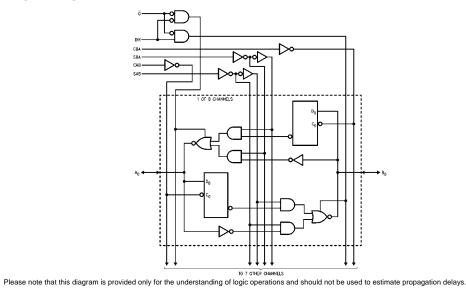
Din Namas	Decemination	U.L.	Input I _{IH} /I _{IL}
Pin Names	Description	HIGH/LOW	Output I _{OH} /I _{OL}
A ₀ –A ₇	Data Register A Inputs/	3.5/1.083	70 μA/–650 μA
	3-STATE Outputs	600/106.6 (80)	–12 mA/64 mA (48 mA)
B ₀ –B ₇	Data Register B Inputs/	3.5/1.083	70 μA/–650 μA
	3-STATE Outputs	600/106.6 (80)	–12 mA/64 mA (48 mA)
СРАВ, СРВА	Clock Pulse Inputs	1.0/1.0	20 µA/–0.6 mA
SAB, SBA	Select Inputs	1.0/1.0	20 µA/–0.6 mA
G	Output Enable Input	1.0/1.0	20 µA/–0.6 mA
DIR	Direction Control Input	1.0/1.0	20 µA/–0.6 mA

Function Table

	Inputs						(Note 1)	Function
G	DIR	CPAB	СРВА	SAB	SBA	A ₀ -A ₇	B ₀ –B ₇	Function
Н	Х	H or L	H or L	Х	Х			Isolation
н	Х	~	Х	Х	Х	Input	Input	Clock A _n Data into A Register
Н	Х	Х	~	Х	Х			Clock B _n Data into B Register
L	Н	Х	Х	L	Х			A _n to B _n —Real Time (Transparent Mode)
L	н	~	Х	L	Х	Input	Output	Clock A _n Data into A Register
L	н	H or L	х	н	Х			A Register to B _n (Stored Mode)
L	н	~	х	н	Х			Clock An Data into A Register and Output to Bn
L	L	Х	Х	Х	L			B _n to A _n —Real Time (Transparent Mode)
L	L	Х	~	Х	L	Output	Input	Clock B _n Data into B Register
L	L	Х	H or L	Х	н			B Register to A _n (Stored Mode)
L	L	Х	~	Х	н			Clock B_n Data into B Register and Output to A_n
H = HIGH Voltage Level L = LOW Voltage Level X = Irrelevant								vant = LOW-to-HIGH Transition

H = HIGH Voltage LevelL = LOW Voltage LevelX = Irrelevant \sim = LOW-to-HIGH TransitionNote 1: The data output functions may be enabled or disabled by various signals at the \overline{G} and DIR Inputs. Data input functions are always enabled;
i.e., data at the bus pins will be stored on every LOW-to-HIGH transition of the clock inputs.

Logic Diagram



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Absolute Maximum Ratings(Note 2)

Storage Temperature	$-65^{\circ}C$ to $+150^{\circ}C$
Ambient Temperature under Bias	$-55^{\circ}C$ to $+125^{\circ}C$
Junction Temperature under Bias	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 3)	-0.5V to +7.0V
Input Current (Note 3)	-30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State (with $V_{CC} = 0V$)	
Standard Output	–0.5V to V _{CC}
3-STATE Output	-0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I _{OL} (mA)
ESD Last Passing Voltage (Min)	4000V

Recommended Operating Conditions

Free Air Ambient Temperature Supply Voltage 74F646

0°C to +70°C +4.5V to +5.5V

Note 2: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 3: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Units	V _{cc}	Conditions
VIH	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IN} = -18 mA (Non I/O Pins)
V _{OH}	Output HIGH 10% V _{CC} Voltage	2.0			V	Min	I _{OH} = -15 mA (A _n , B _n)
V _{OL}	Output LOW 10% V _{CC} Voltage			0.55	V	Min	$I_{OL} = 64 \text{ mA} (A_n, B_n)$
IIH	Input HIGH Current			5.0	μΑ	Max	V _{IN} = 2.7V (Non I/O Pins)
I _{BVI}	Input HIGH Current Breakdown Test			7.0	μΑ	Max	V _{IN} = 7.0V (Non I/O Pins)
I _{BVIT}	Input HIGH Current Breakdown (I/O)			0.5	mA	Max	V _{IN} = 5.5V (A _n , B _n)
I _{CEX}	Output HIGH Leakage Current			50	μA	Max	$V_{OUT} = V_{CC}$
V _{ID}	Input Leakage Test	4.75			V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current			3.75	μΑ	0.0	V _{IOD} = 150 mV All Other Pins Grounded
IIL	Input LOW Current			-0.6	mA	Max	V _{IN} = 0.5V (Non I/O Pins)
I _{IH} + I _{OZH}	Output Leakage Current			70	μΑ	Max	$V_{OUT} = 2.7V (A_n, B_n)$
$I_{IL} + I_{OZL}$	Output Leakage Current			-650	μΑ	Max	$V_{OUT} = 0.5V (A_n, B_n)$
I _{OS}	Output Short-Circuit Current	-100		-225	mA	Max	$V_{OUT} = 0V$
I _{ZZ}	Bus Drainage Test			500	μΑ	0.0V	$V_{OUT} = 5.25V$
ICCH	Power Supply Current			135	mA	Max	V _O = HIGH
I _{CCL}	Power Supply Current			150	mA	Max	V _O = LOW
I _{CCZ}	Power Supply Current			150	mA	Max	V _O = HIGH Z

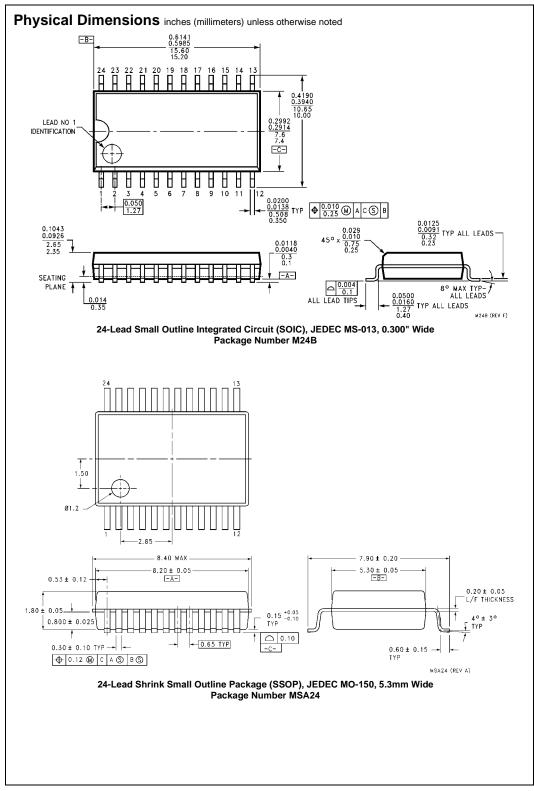
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AC Electrical Characteristics

Symbol			+25°C	$T_{A} = -55^{\circ}C \text{ to } +125^{\circ}C$		$T_A = 0^{\circ}C$ to +70°C			
	Parameter	V _{CC} =	+ 5.0V	V _{CC} =	+5.0V	V _{CC} =	Units		
	Faidilielei	C _L =	50 pF	C _L =	50 pF	$C_L = 50 \ pF$			
		Min	Max	Min	Max	Min	Max		
f _{MAX}	Maximum Clock Frequency	90		75		90		MHz	
t _{PLH}	Propagation Delay	2.0	7.0	2.0	8.5	2.0	8.0		
t _{PHL}	Clock to Bus	2.0	8.0	2.0	9.5	2.0	9.0	ns	
t _{PLH}	Propagation Delay	1.0	7.0	1.0	8.0	1.0	7.5	ns	
t _{PHL}	Bus to Bus	1.0	6.5	1.0	8.0	1.0	7.0	115	
t _{PLH}	Propagation Delay	2.0	8.5	2.0	11.0	2.0	9.5	200	
t _{PHL}	SBA or SAB to A or B	2.0	8.0	2.0	10.0	2.0	9.0	ns	
t _{PZH}	Enable Time	2.0	8.5	2.0	10.0	2.0	9.0	ns	
t _{PZL}	OE to A or B	2.0	12.0	2.0	13.5	2.0	12.5	115	
t _{PHZ}	Disable Time	1.0	7.5	1.0	9.0	1.0	8.5	ns	
t _{PLZ}	OE to A or B	2.0	9.0	2.0	11.0	2.0	9.5	115	
t _{PZH}	Enable Time	2.0	14.0	2.0	16.0	2.0	15.0	ns	
t _{PZL}	DIR to A or B	2.0	13.0	2.0	15.0	2.0	14.0	115	
t _{PHZ}	Disable Time	1.0	9.0	1.0	10.0	1.0	9.5	ns	
t _{PLZ}	DIR to A or B	2.0	11.0	2.0	12.0	2.0	11.5	ns	

AC Operating Requirements

		$T_{A} = +25^{\circ}C$ $V_{CC} = +5.0V$		$T_A = -55^{\circ}C$	c to +125°C	$T_A = 0^{\circ}C$ to +70°C			
Symbol	Parameter			$V_{CC} = +5.0V$		$V_{CC} = +5.0V$		Units	
		Min	Max	Min	Max	Min	Max		
t _S (H)	Setup Time, HIGH or LOW	5.0		5.0		5.0			
t _S (L)	Bus to Clock	5.0		5.0		5.0		ns	
t _H (H)	Hold Time, HIGH or LOW	2.0		2.5		2.0		ns	
t _H (L)	Bus to Clock	2.0		2.5		2.0		115	
t _W (H)	Clock Pulse Width	5.0		5.0		5.0		ns	
t _W (L)	HIGH or LOW	5.0		5.0		5.0		115	



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